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Vishay Siliconix

Automotive N-Channel 72 V (D-S) 175 °C MOSFET



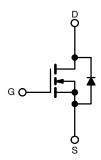
Marking code: Q079

PRODUCT SUMMARY				
V _{DS} (V)	72			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.0095			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$	0.0120			
I _D (A) ^a	54			
Configuration	Single			

FEATURES

- TrenchFET® Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % Rq and UIS tested
- · Wettable flank terminals
- Low thermal resistance with 0.75 mm profile
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912





N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK® 1212-8SLW
Lead (Pb)-free and halogen-free	SQS178ELNW (for detailed order number please see www.vishay.com/doc?79771)

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	72	.,	
Gate-source voltage		V _{GS}	± 20	V	
Continuous drain current ^a	T _C = 25 °C	1	54		
	T _C = 125 °C	I _D	31		
Continuous source current (diode conduction) a		I _S	59	А	
Pulsed drain current a, b		I _{DM}	115		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	21		
Single pulse avalanche energy	L = 0.1 IIII	E _{AS}	22	mJ	
Maximum power dissipation a, b	T _C = 25 °C	D ₋	65	W	
	T _C = 125 °C	P_D	21		
Operating junction and storage temperature range Soldering recommendations (peak temperature) c		T _J , T _{stg}	-55 to +175	°C	
			260		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount d	R_{thJA}	54	°C/W	
Junction-to-case (drain) ^e		R_{thJC}	2.3		

Notes

- a. Values based on R_{thJC} and T_C of 25 °C. Actual values achievable will be dependent on the thermal characteristics of the complete system
- b. Pulse test; pulse width $\leq 300~\mu s, \ duty \ cycle \leq 2~\%$
- c. See solder profile (www.vishay.com/doc?73257). A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- d. When mounted on 1" square PCB (FR4 material)
- e. As per on JESD51-14

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SPECIFICATIONS (T _C = 25 °C, u	SYMBOL		T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	STINIDOL	123	TOONDITIONS	IVIIIV.	111.	WAX.	ONIT
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0, I _D = 250 μA		72	_	_	
Gate-source threshold voltage	V _{GS(th)}	$V_{GS} = V_{GS}, I_D = 250 \mu\text{A}$		1.2	1.7	2.5	V
Gate-source leakage	I _{GSS}		$V_{DS} = V_{GS}, I_D = 230 \mu\text{A}$ $V_{DS} = 0 \text{V}, V_{GS} = \pm 20 \text{V}$		-	± 100	nA
date source realizage	'GSS	$V_{GS} = 0 V$	V _{DS} = 72 V		_	1	117 (
Zero gate voltage drain current	I _{DSS}		V _{DS} = 72 V, T _J = 125 °C		_	50	μA
Zoro gato voltago aram ourront	יטכט	$V_{GS} = 0 V$	$V_{DS} = 72 \text{ V}, T_{J} = 175 \text{ °C}$	_	_	150	- μΑ
On-state drain current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} = 72 \text{ V}, 13 = 173 \text{ S}$ $V_{DS} \ge 5 \text{ V}$	20	_	-	Α
0.1. 0.1.1.0 0.1.1.0.1.1	·D(OII)	$V_{GS} = 4.5 \text{ V}$	103 = 0 1		0.0095	0.012	Ω
		V _{GS} = 10 V	I _D = 10 A	_	0.007	0.0095	
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 10 V	I _D = 10 A, T _J = 125 °C	_	-	0.0178	
		V _{GS} = 10 V		_	_	0.0220	
Forward transconductance b	9 _{fs}		= 15 V, I _D = 55 A	_	76	-	S
Dynamic ^b	0.0		, 5				
Input capacitance	C _{iss}	V _{GS} = 0 V	V _{DS} = 25 V, f = 1 MHz	_	1522	2131	pF
Output capacitance	C _{oss}			-	264	370	
Reverse transfer capacitance	C _{rss}			_	9	15	
Total gate charge ^c	Qg		V _{DS} = 36 V, I _D = 4 A	-	26	39	nC
Gate-source charge ^c	Q _{gs}	V _{GS} = 10 V		-	5	-	
Gate-drain charge ^c	Q _{gd}			-	5	-	
Gate resistance	R_g		f = 1 MHz		1.0	1.6	Ω
Turn-on delay time ^c	t _{d(on)}			-	10	15	
Rise time ^c	t _r	$V_{DD} = 36 \text{ V}, \text{ R}_L = 14.4 \ \Omega,$ $I_D \cong 2.5 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \ \Omega$		-	3	6	
Turn-off delay time ^c	t _{d(off)}			-	23	35	ns -
Fall time ^c	t _f			-	9	14	
Source-Drain Diode Ratings and Charac	teristic ^b						
Pulsed current ^a	I _{SM}			-	-	115	Α
Forward voltage	V _{SD}	I _F = 10 A, V _{GS} = 0 V		-	0.82	1.1	V
Body diode reverse recovery time	t _{rr}	V_{DD} = 58 V, I_{FM} = 3.5 A, di/dt = 100 A/μs, R = 10 Ω, L = 0.3 mH, pulse width = 2 μs		-	30	60	ns
Body diode reverse recovery charge	Q_{rr}			-	23	46	nC
Reverse recovery fall time	ta			-	15	-	
Reverse recovery rise time	t _b			-	15	-	ns
Body diode peak reverse recovery current	I _{RM(REC)}			-	-1.3	-	Α

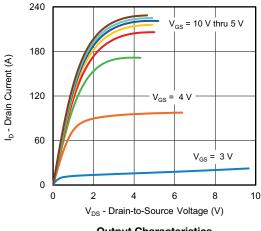
Notes

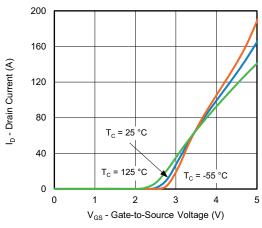
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



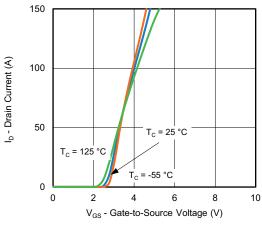
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

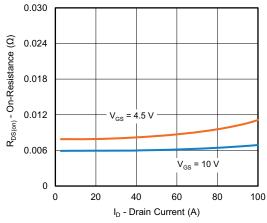






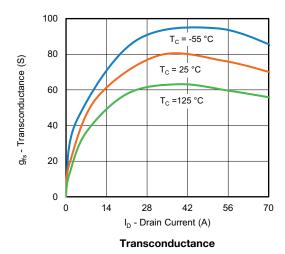


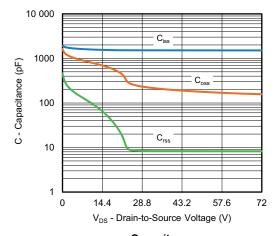




Transfer Characteristics

On-Resistance vs. Drain Current

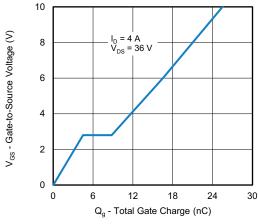




100 125 150 175



TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)





82 81

80

79 78

77 76 75

74 73

72 71

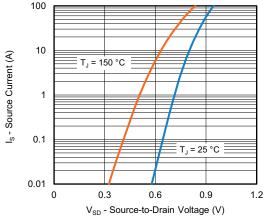
-25

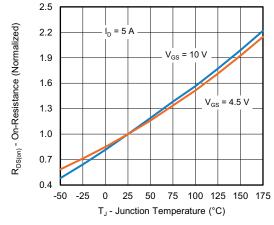
V_{DS} - Drain-to-Source Voltage (V)

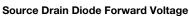
 $I_D = 1 \text{ mA}$

25 50 75

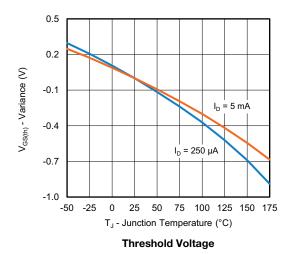
T_J - Junction Temperature (°C)

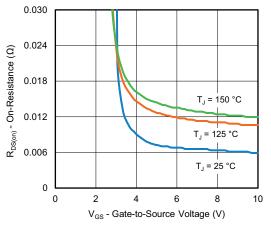






On-Resistance vs. Junction Temperature

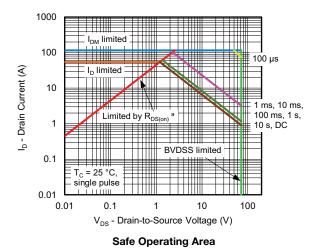




On-Resistance vs. Gate-to-Source Voltage



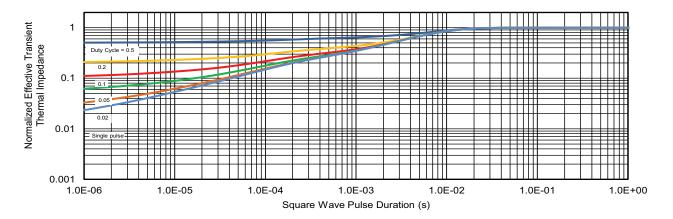
THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



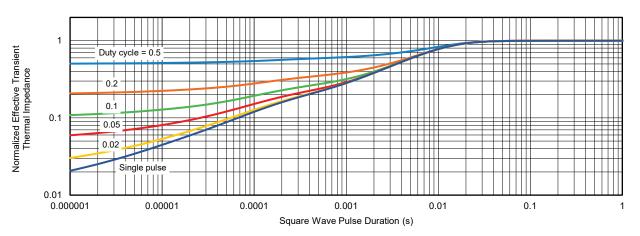
Note

a. $V_{GS} > \mbox{minimum} \ V_{GS}$ at which $R_{DS(on)}$ is specified





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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